

# SID

Factory: Rot am See

Article:

483

ML4

Provided:

Kracht, Enrico

Customer:

Date:

08.06.2015



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
---------------	----------	----	---------	------------------

A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	A00 B00
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	150		2	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		3	
C-RS-FR4-ML-0.41mm-070+070-TG150-HF	50200759	70	L2	4	
		410			
		70	L3		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	150		5	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		6	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	7	

Thickness after Pressing

B00:

890 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

990 µm

Dmin:

790 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1000 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

1100 µm

Dmin:

900 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

886 µm

Version 1.2.14.15

© Würth Elektronik